Si4056ADY

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Vishay Siliconix



PRODUCT SUMMARY					
V _{DS} (V)	100				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0292				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.0330				
Q _g typ. (nC)	8.8				
I _D (A)	8.3				
Configuration	Single				

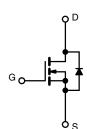
FEATURES

N-Channel 100 V (D-S) MOSFET

- TrenchFET[®] Gen IV power MOSFET
- Very low R_{DS} x Q_g figure-of-merit (FOM)
- Tuned for the lowest R_{DS} x Q_{oss} FOM
- Logic level gate drive
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Synchronous rectification
- · Primary side switch
- DC/DC converter
- Motor drive switch
- LED driver
- Load switch



N-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and halogen-free	Si4056ADY-T1-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	100	V	
Gate-source voltage		V _{GS}	± 20	V	
	T _C = 25 °C		8.3		
	T _C = 70 °C	Τ.Γ	6.6		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	5.9 ^{b, c}		
	T _A = 70 °C	1 1	4.7 ^{b, c}	A	
Pulsed drain current (t = 100 μs)		I _{DM}	40	A	
Continuous source-drain diode current	T _C = 25 °C		4.5		
	T _A = 25 °C	I _S	2.3 ^{b, c}		
Single pulse avalanche current	e pulse avalanche current L = 0.1 mH		12		
Single pulse avalanche energy	L = 0.1 MH	E _{AS}	7.2	mJ	
	T _C = 25 °C		5.0		
Maximum power dissipation	T _C = 70 °C		3.2		
	T _A = 25 °C	P _D	2.5 ^{b, c}	W	
	T _A = 70 °C	1 1	1.6 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) ^c		Ŭ Ŭ	260	-0	

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum junction-to-ambient ^b	t ≤ 10 s	R _{thJA}	43	50	°C/W		
Maximum junction-to-case (drain)	Steady state	R _{thJC}	19	25	C/W		

Notes

a. $T_C = 25 \ ^{\circ}C$

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. Maximum under steady state conditions is 92 °C/W

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(Pb) RoHS

HALOGEN

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	• •						
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	100	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 10 mA	-	85	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-4.5	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	-	2.5	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	100	nA	
Zara gata valtaga drain avreat		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1		
Zero gate voltage drain current	IDSS	V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 70 °C	-	-	15	μA	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 10$ V, $V_{GS} = 10$ V	20	-	-	Α	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5.9 \text{ A}$	-	0.0243	0.0292	_	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$	-	0.0277	0.0330	Ω	
Forward transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 10 A	-	49	-	S	
Dynamic ^b			•				
Input capacitance	C _{iss}		-	1330	-		
Output capacitance	C _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	69	-	pF	
Reverse transfer capacitance	C _{rss}		-	7.2	-		
Total gate charge	Qg	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$	-	19.2	29	nC	
			-	8.8	14		
Gate-source charge	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	4.3	-		
Gate-drain charge	Q _{gd}		-	2.1	-		
Output charge	Q _{oss}	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	13.6	-		
Gate resistance	Rg	f = 1 MHz	0.3	0.87	1.5	Ω	
Turn-on delay time	t _{d(on)}		-	9	18	_	
Rise time	t _r	$V_{DD} = 50 \text{ V}, \text{ R}_{I} = 5 \Omega, \text{ I}_{D} \cong 10 \text{ A},$	-	6	12		
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = 10$ V, $R_{g} = 1$ Ω	-	19	38		
Fall time	t _f		-	4	8		
Turn-on delay time	t _{d(on)}		-	14	28	ns	
Rise time	tr	$V_{DD} = 50 \text{ V}, \text{ R}_{\text{I}} = 5 \Omega, \text{ I}_{\text{D}} \cong 10 \text{ A},$	-	8	16	1	
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	15	30		
Fall time	t _f		-	5	10		
Drain-Source Body Diode Characteristi	cs						
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	35.4		
Pulse diode forward current	I _{SM}		-	-	40	A	
Body diode voltage	V _{SD}	$I_{\rm S} = 5$ A, $V_{\rm GS} = 0$ V	-	0.78	1.1	V	
Body diode reverse recovery time	t _{rr}		-	29	58	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/μs,	-	39	78	nC	
Reverse recovery fall time	t _a	$T_{\rm J} = 25 ^{\circ}{\rm C}$	-	25	-		
Reverse recovery rise time	t _b		-	4	_	ns	

Notes

a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$

b. Guaranteed by design, not subject to production testing

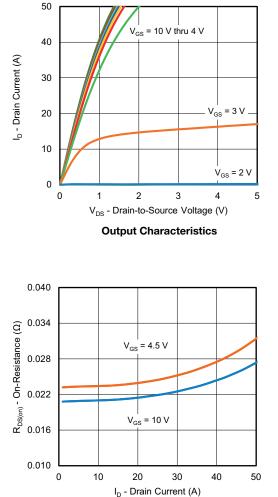
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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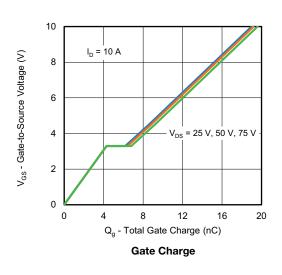


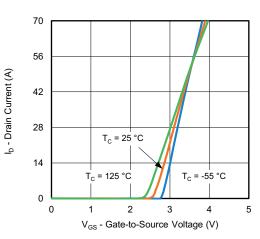
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

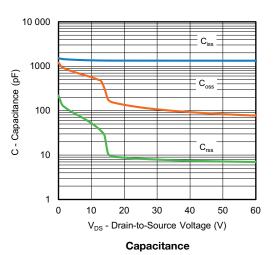


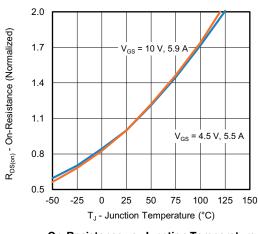
On-Resistance vs. Drain Current and Gate Voltage





Transfer Characteristics





On-Resistance vs. Junction Temperature

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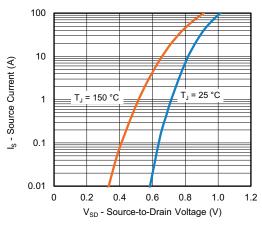
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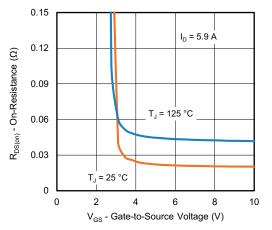


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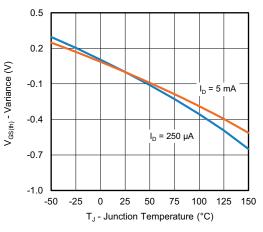
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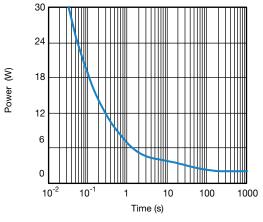
Source-Drain Diode Forward Voltage



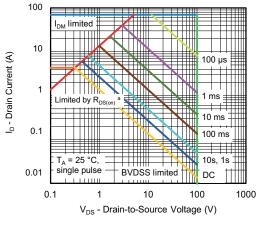
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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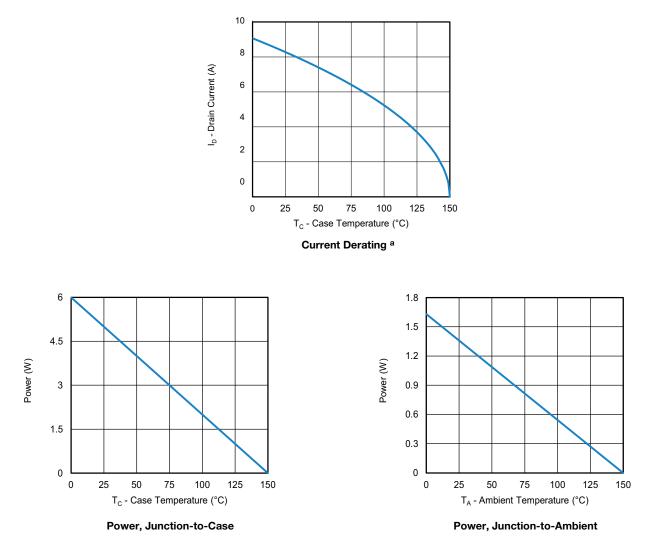
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

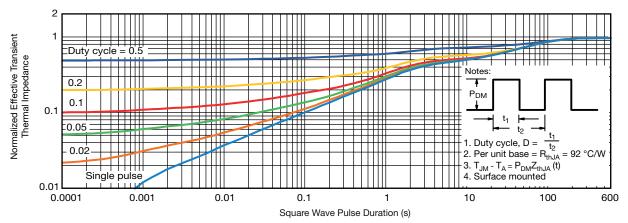
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



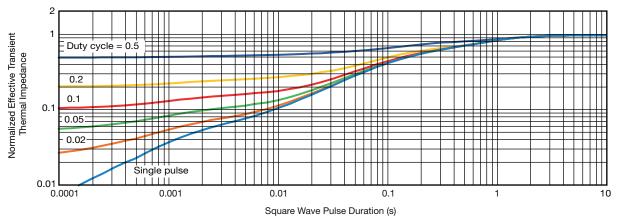
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?78131.

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Package Information

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	INCHES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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